

The products are 4-pin optical relays. The device consists of an AlGaAs infrared emitting diode input stage optically coupled to a high-voltage output detector circuit in a plastic SOP4 package. The detector consists of a high-speed photovoltaic diode array and driver circuitry. The products are widely used in measuring and testing equipment, security and disaster prevention market, industrial machinery and equipment.

High isolation 3750 Vrms

Operating temperature range -40°C to 125°C

REACH & RoHS compliance

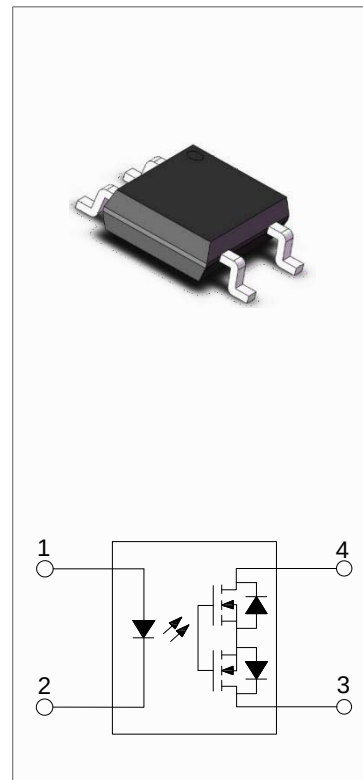
HBM: H3A; MM: M4; CDM: C3

CQC approved

VDE approved

UL approved

AECQ101 approved



(Temperature=25°C)

Input	Forward Current	I_F	50	mA
	Peak Forward Current	I_{FP}	1	A
	Reverse Voltage	V_R	6	V
	Input Power Dissipation	P_D	75	mW
Output	Load Voltage	V_O	600	V
	Continuous load current	I_O	0.05	A
	Output Power Dissipation	P_O	300	mW
Total Power Dissipation		P_{tot}	375	mW
Isolation Voltage		V_{iso}	3750	Vrms
Operating Temperature		T_{opr}	-40~125	
Junction Temperature		T_j	1 5	
Storage Temperature		T_{stg}	-55~125	



Soldering Temperature	T_{sol}	260	
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100 μ s pulse, 100Hz frequency
AC for 1minute, R.H.=40~60%

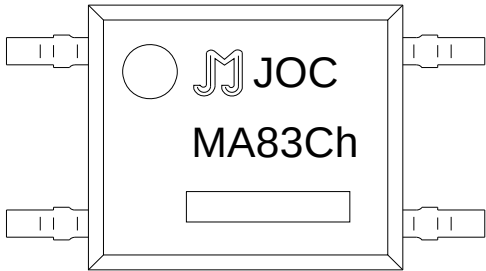
(Temperature=25°C)

Input	Forward Voltage	V_F	$I_F=10mA$	-	1.3	1.5	V
	Reverse Current	I_R	$V_R=6V$	-	-	1	μA
	Action Current	$I_{F(ON)}$	$I_O=I_{O(MAX)}$	-	0.9	3	mA
	Reset Current	$I_{F(OFF)}$	$I_O=I_{O(MAX)}$	0.4	0.8	-	mA
Output	On Resistance	R_{on}	$I_F=5mA$ $I_O=Max.$ Within 1s on time	-	30	40	Ω
	Off State Leakage Current	I_{Leak}	$I_F=0mA$, $V_O=Max.$	-	-	1	μA
	Output Capacitance	C_{OFF}	$V_{OFF}=0V$, $f_o=1MHz$	10	-	1000	pF
Switching Characteristics	Isolation Resistance	R_{ISO}	DC500V 40~60%R.H.	10^{12}	-	-	Ω
	Floating Capacitance	C_{IO}	$V=0$, $f=1MHz$	-	0.8	-	pF
	Turn On Time	t_{on}	$I_F=5mA$, $I_O=Max.$	-	0.18	0.5	ms
	Turn Off Time	t_{off}	$I_F=5mA$, $I_O=Max.$	-	0.2	1	ms



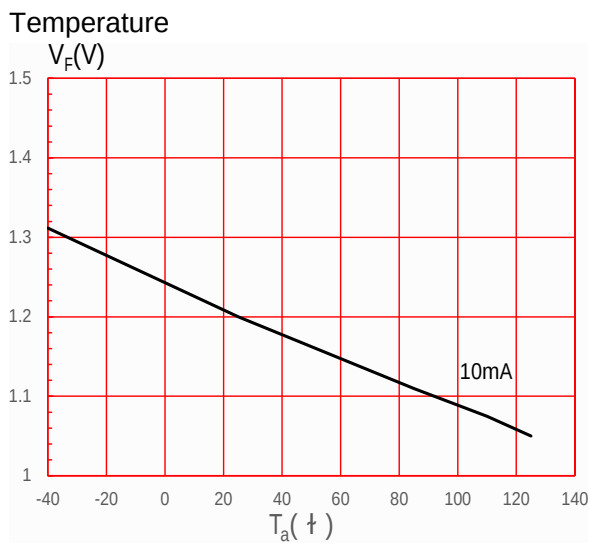
J	OC	M	A	8	3	C	h	-M4	/
JieJie Microelectronics Co., Ltd.	Opto Coupler	MOS	A:1NO	8:V _O 600V	3:I _O :0.05A	I _{FT} 3mA	h:Automotive-grade	SOP4	None:T1 R:T2

SOP4	3000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box =30k Units

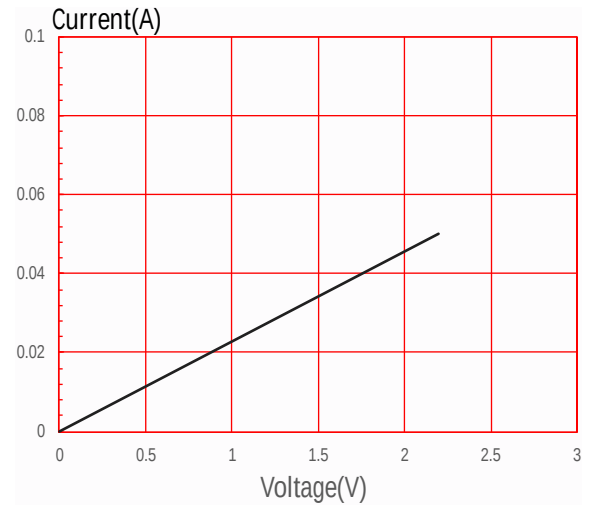
	 Production Information Code
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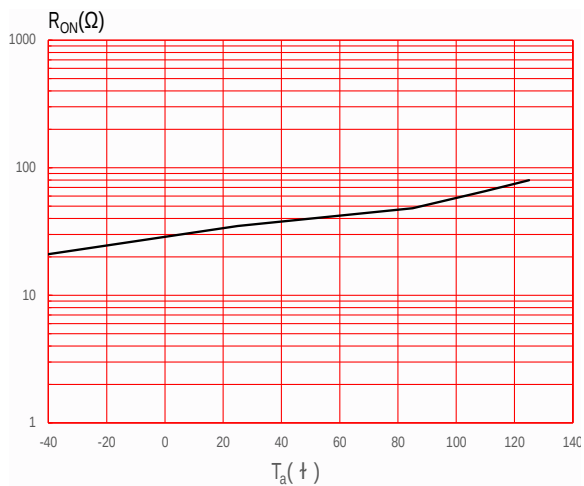
LED Dropout Voltage vs. Ambient



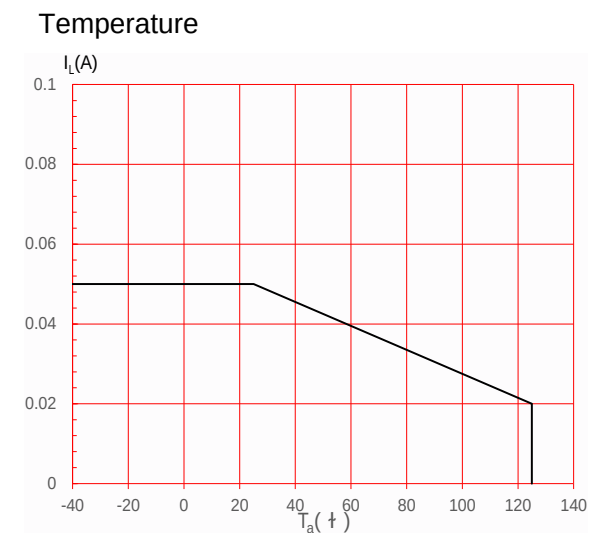
Output Current vs. Output Voltage



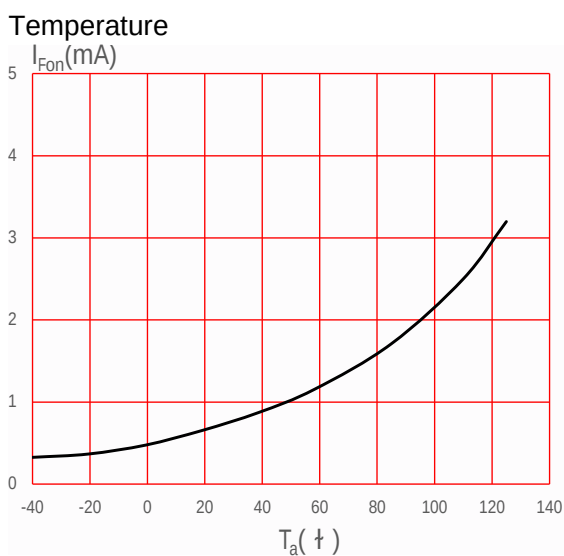
On Resistance vs. Ambient Temperature



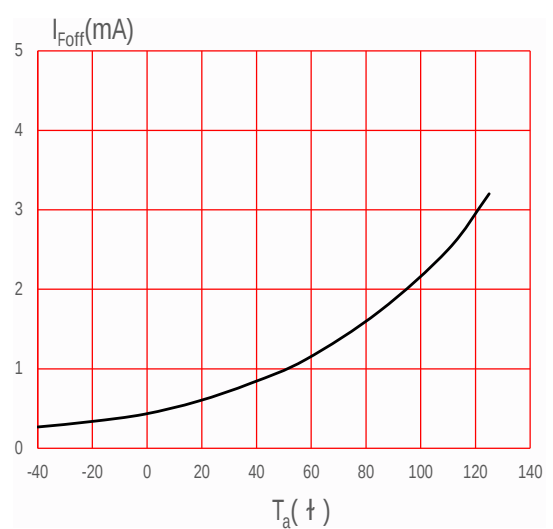
Load Current vs. Ambient



LED Operate Current vs. Ambient

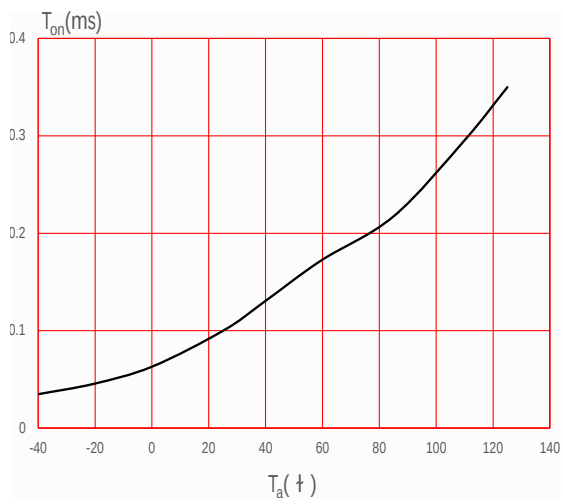


LED Turn Off Current vs. Ambient Temperature

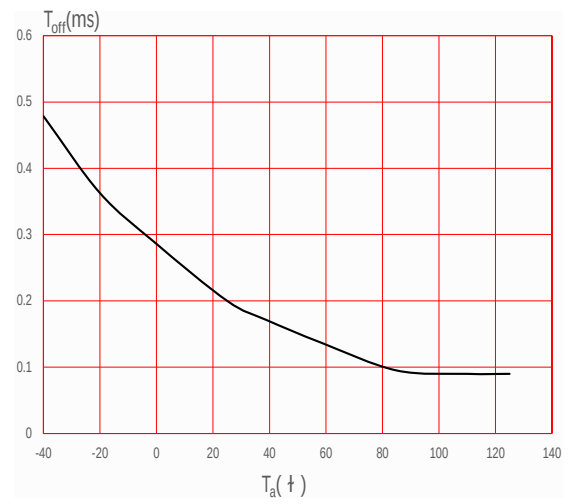




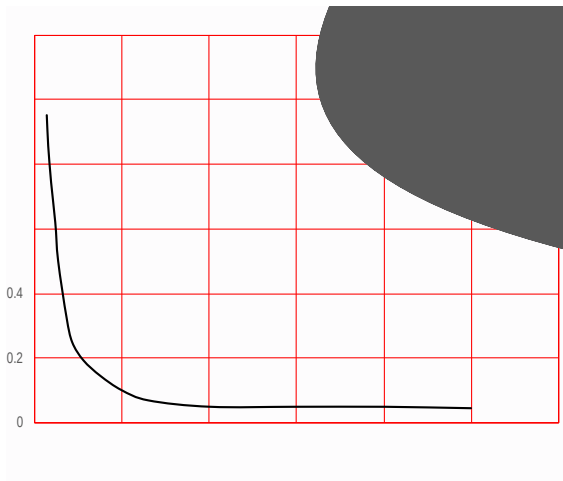
Turn On Time vs. Ambient Temperature



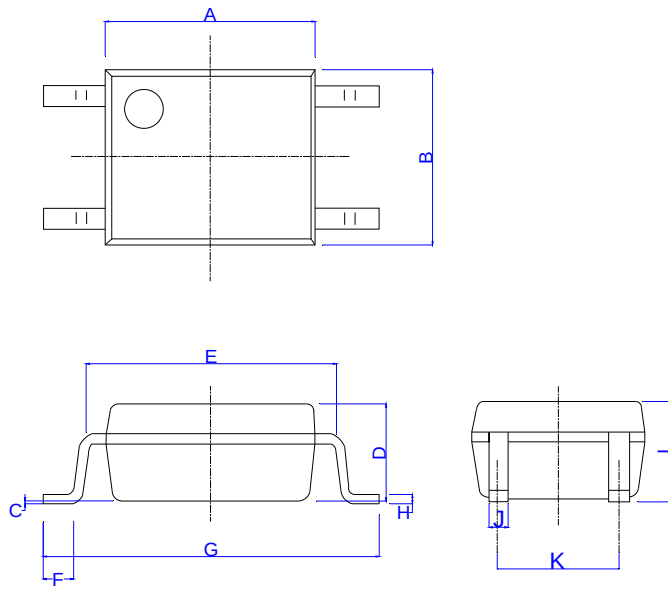
Turn Off Time vs. Ambient Temperature



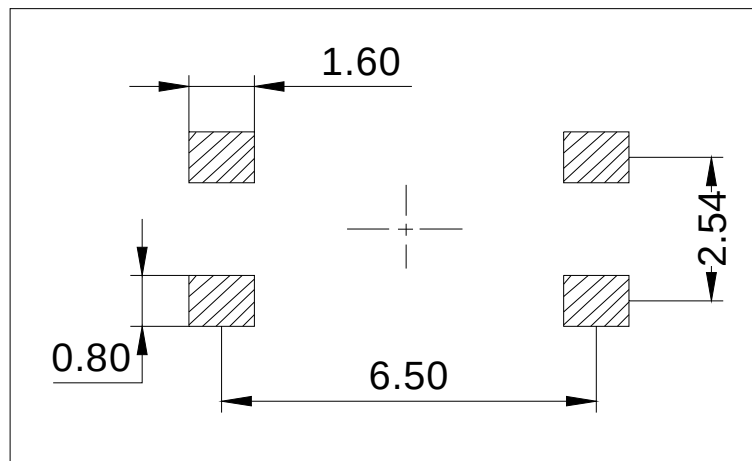
Turn On Time vs. LED Forward Current

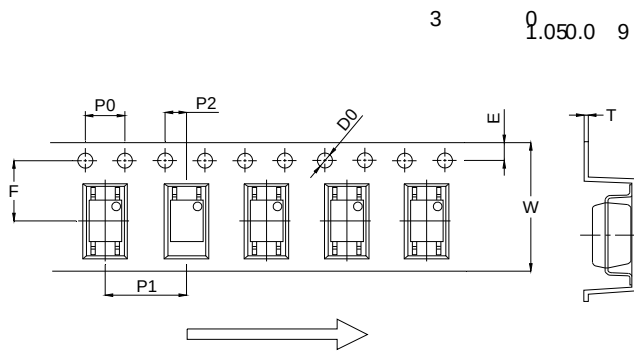


Turn Off Time vs. LED Forward Current

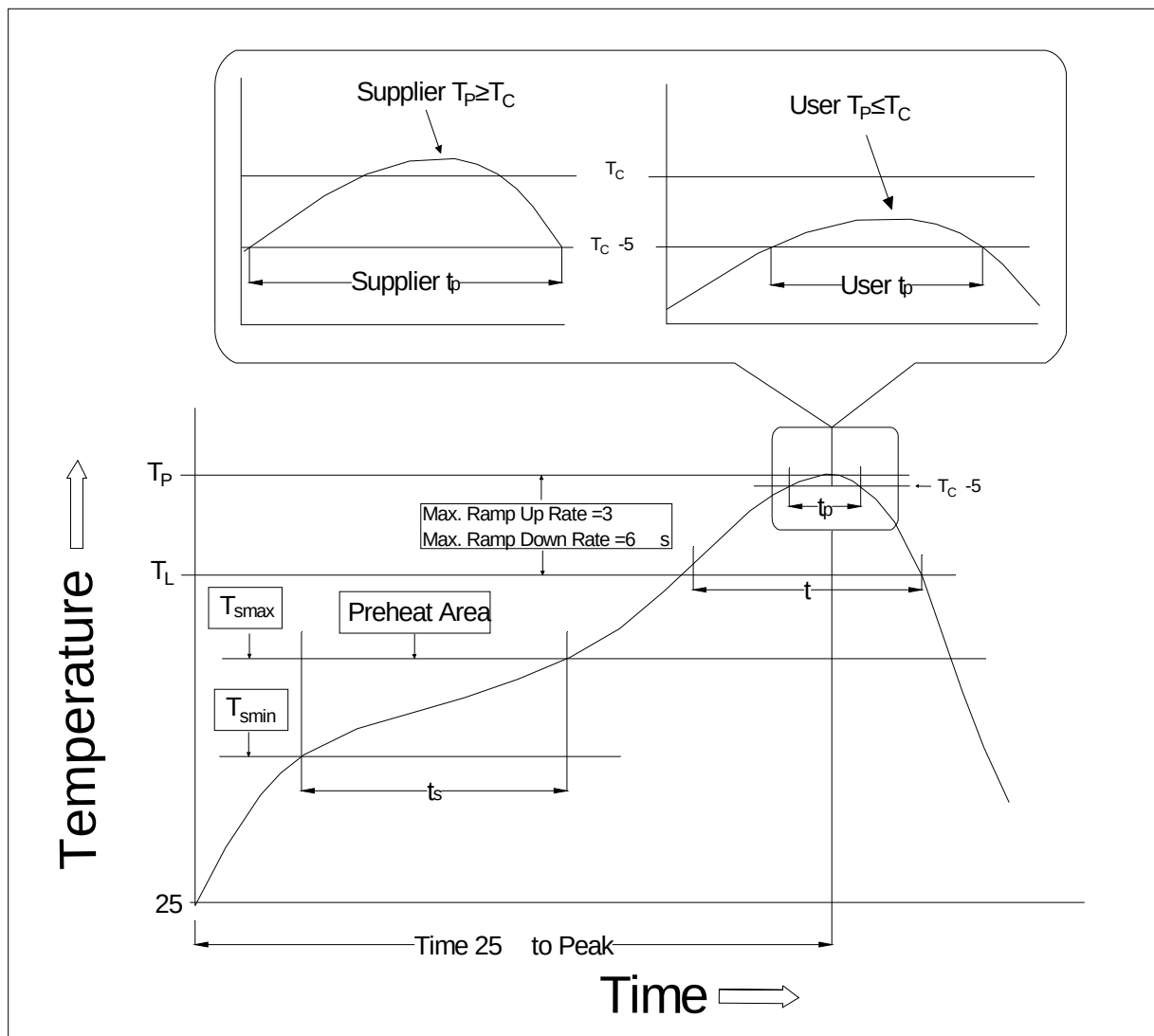


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.80	0.173		0.189
B	3.60		4.20	0.142		0.165
C	0.00		0.20	0.000		0.008
D	1.90		2.30	0.075		0.091
E	5.00		5.60	0.197		0.220
F	0.34		0.94	0.013		0.037
G	6.70		7.30	0.264		0.287
H	0.10		0.30	0.004		0.012
I	2.00		2.40	0.079		0.094
J	0.25		0.55	0.010		0.022
K	2.29		2.79	0.090		0.110





Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1s	1.85	0.065		0.073
F	4.40		4.60	0.173		0.181
T	0.25		0.35	0.010		0.014
W	11.90		12.30	0.469		0.484



Temperature Min. (T_{smin})	100	150
Temperature Max. (T_{smax})	150	200
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3 /second max.	3 /second max.
Liquidus Temperature (T_L)	183	217
Time (t_L) Maintained Above (T_L)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235 +0 /-5	260 +0 /-5
Time (t_P) within 5 of 260	10 seconds	10 seconds
Ramp-down Rate (T_P to T_L)	3-6 /second	3-6 /second
Time 25 to Peak Temperature	6 minutes max.	8 minutes max.



Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;
Recommend storage humidity: <60%;
MSL level: MSL 1

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